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LITE-ON DCC

RELEASE

BNS-OD-FC001/A4

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LED DISPLAY LTS-3386CKR-P

LED DISPLAY

LTS-3386CKR-P

<u>Rev</u>	Description	By	<u>Date</u>
01	Preliminary Spec.	Reo Lin	02/12/2014
	Above data for PD and Customer track	ing only	
-	NPPR Received and Upload on System	Reo Lin	02/18/2014
А	Update Packing spec. in page 9	Reo Lin	01/13/2020





LED DISPLAY LTS-3386CKR-P

1. Description

The LTS-3386CKR-P is a 0.3 inch (7.62 mm) digit height single digit SMD display. This device uses AS-AllnGap Super Red chips (AllnGap epi on GaAs substrate). The display has gray face and white segments.

1.1 Features

- 0.3 inch (7.62 mm) DIGIT HEIGHT
- CONTINUOUS UNIFORM SEGMENTS
- LOW POWER REQUIREMENT
- EXCELLENT CHARACTERS APPEARANCE
- HIGH BRIGHTNESS & HIGH CONTRAST
- WIDE VIEWING ANGLE
- SOLID STATE RELIABILITY
- CATEGORIZED FOR LUMINOUS INTENSITY.
- LEAD-FREE PACKAGE(ACCORDING TO ROHS)

1.2 Device

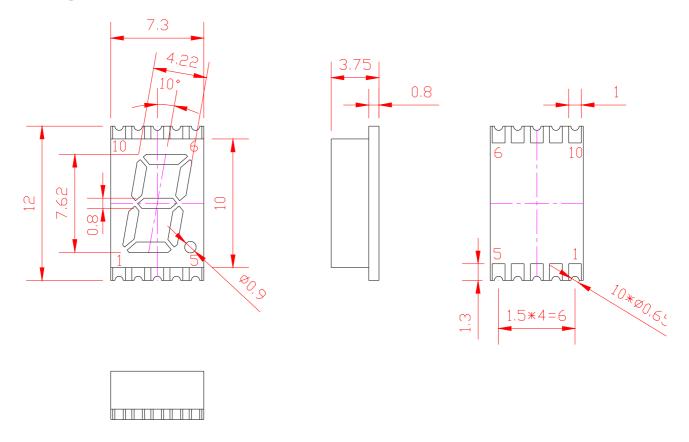
Part No	Description	
AlinGap Super Red	Common Cathode	
LTS-3386CKR-P	Rt. Hand Decimal	





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2. Package Dimensions



Notes :

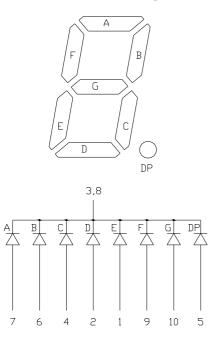
- 1. All dimensions are in millimeters. Tolerances are ± 0.25 mm (0.01") unless otherwise noted
- 2. Foreign material on segment ≤ 10 mil
- 3. Ink contamination (surface) \leq 20mils
- 4. Bubble in segment ≤ 10 mil
- 5. Bending \leq 1% of reflector length
- 6. Plastic pin's burr max is 0.1 mm





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3. Internal Circuit Diagram



4. Pin Connection

No	Connection
1	ANODE E
2	ANODE D
3	COMMON CATHODE
4	ANODE C
5	ANODE DP
6	ANODE B
7	ANODE A
8	COMMON CATHODE
9	ANODE F
10	ANODE G





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5. Rating and Characteristics

5.1. Absolute Maximum Rating at Ta=25°C

Parameter	Maximum Rating	Unit	
Power Dissipation Per Segment	70	mW	
Peak Forward Current Per Segment (1/10 Duty Cycle, 0.1ms Pulse Width)	60	mA	
Continuous Forward Current Per Segment	25	mA	
Derating Linear From 25°C Per Segment	0.28	mA/℃	
Operating Temperature Range	-35℃ to +105℃		
Storage Temperature Range	-35℃ to +105℃		

Iron Soldering Conditions: 1/16 inch Below Seating Plane for 3 Seconds at 260°C

5.2. Electrical / Optical Characteristics at Ta=25°C

Parameter	Symbol	MIN.	TYP.	MAX.	Unit	Test Condition
Average Luminous Intensity Der Comment	IV	201	650		μcd	IF=1mA
Average Luminous Intensity Per Segment			8250		μcd	IF=10mA
Peak Emission Wavelength	λр		639		nm	IF=20mA
Spectral Line Half-Width	Δλ		20		nm	IF=20mA
Dominant Wavelength	λd		631		nm	IF=20mA
Forward Voltage Per Chip	VF		2.05	2.6	V	IF=20mA
Reverse Current Per Segment ⁽²⁾	IR			100	μA	VR=5V
Luminous Intensity Matching Ratio (Similar Light Area)	IV-m			2:1		IF=1mA

Notes :

1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE (Commission International De L'Eclariage) eye-response curve

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- 2. Reverse voltage is only for IR test. It cannot continue to operate at this situation
- 3. Cross talk specification \leq 2.5%



RELATIVE INTENSITY (%)

Data Sheet

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5.5. Typical Electrical / Optical Characteristics Curves

KR 100 50 0 600 500 550 750 800 650 700 PEAK WAVELENGTH λ p (nm) Fig1.Spectral Emission KR 160 4
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 3.5 3 KR 2.5 2 0 ∟ 0 0<u>°</u> 1.0 2.0 3.0 4.0 FORWARD VOLTAGE, Vf (Volts) 10 15 20 25 30 5.0 5 FORWARD CURRENT, If (mA) Fig3. Relative Luminous Intensity Fig2. Forward Current vs. Forward Voltage vs. DC Forward Current 40 1000 (Value) 40 (Value) 35 MAXIMUM DC CURRENT, Imax 0 2 01 02 02 02 0 KR KR 0 10 0 10 20 30 40 50 60 70 80 90 100 110 2 5 10 20 50 DUTY CYCLE % (Frequency 1Khz) 1 100 AMBIENT TEMPERATURE, Ta (°C) Fig4. Maximun Allowable DC Current vs. Ambient Temperature Fig5. Maximum Peak Current vs. Duty Cycle %

(25°C Ambient Temperature Unless Otherwise Noted)



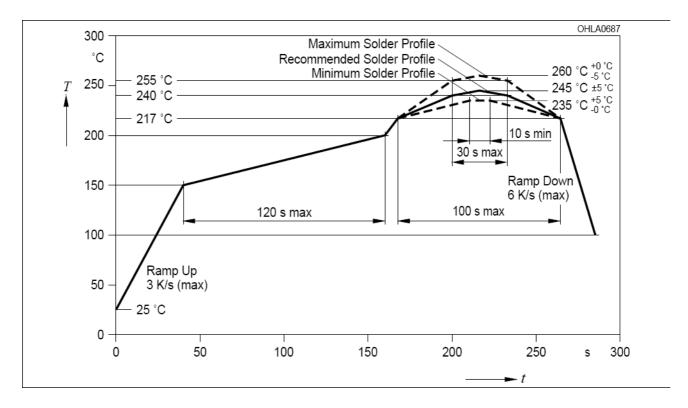
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6. SMT SOLDERING INSTRUCTION

(Number of reflow process shall be less than 2 times, and cooling process to normal temperature is required between the first and the second soldering process)



Notes :

1. Recommended soldering condition

Reflow Soldering (Two times only)		Soldering Iron (One time only)		
Pre-heat:	120~150°C.	Temperature	300°C Max.	
Pre-heat time:	120sec. Max.	Soldering time	3sec. Max.	
Peak temperature:	260℃ Max.	_		
Soldering time:	5sec. Max.			

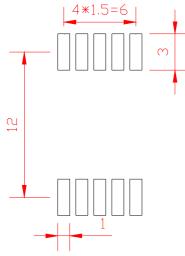
2. Number of reflow process shall be less than 2 times, and cooling process to normal temperature is required between the first and the second soldering process.

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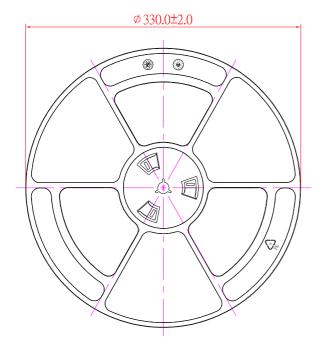
7. Recommended Soldering Pattern

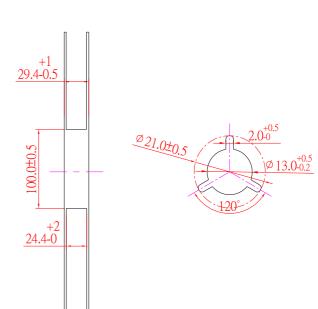


Note: All dimensions are in millimeters.

8. Packing Specification

8.1. Packing Reel Dimensions



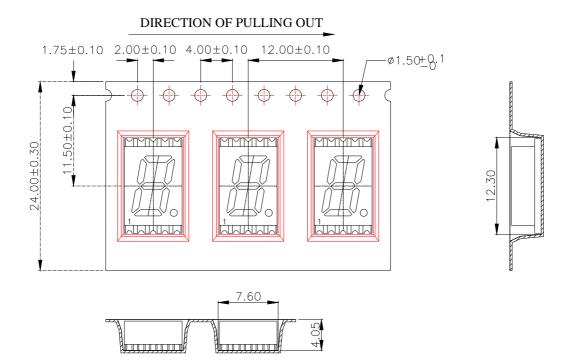


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8.2. Packing Carrier Dimensions

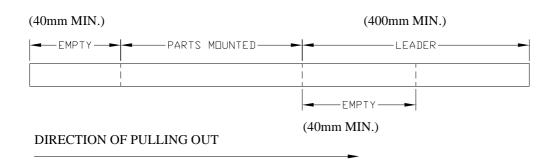


1. 10 sprocket hole pitch cumulative tolerance ±0.20.
 2. Carrier camber is within 1 mm in 250 mm.

- 3. Material : Black Conductive Polystyrene Alloy.
- 4. All dimensions meet EIA-481-D requirements.
- 5. Thickness : 0.30±0.05mm.

6. Packing length per 22" reel : 46.0 Meters.(1:3)
7. Component load per 13" reel : 1200 pcs.
8. Minimum packing quantity is 300 pcs for remainders

8.3.Trailer part / Leader part



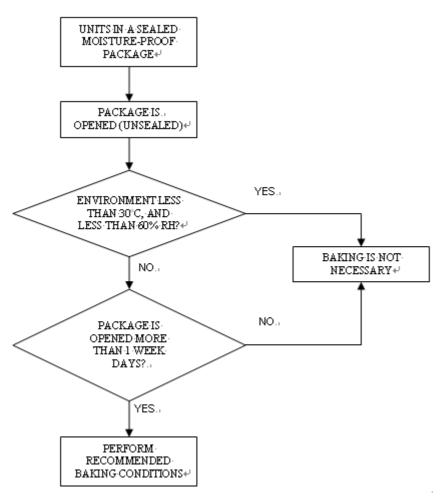


Part No. : LTS-3386CKR-P BNS-OD-FC002/A4

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9. Moisture Proof Packing

All N/D SMD displays are shipped in moisture proof package. The displays should be stored at 30° C or less and 60° RH or less. Once the package opened, moisture absorption begins.



If the parts are not stored in dry conditions, they must be baked before reflow to prevent damage to the parts. Baking should only be done once

Package	Temperature	Time
In Reel	60°C	≧48hours
In Bulk	100°C	≥4hours
	125°C	≧2hours